

1A, 200V Surface Mount Ultra Fast Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Ultra fast recovery time for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



DO-214AC (SMA)

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound: UL flammability classification rating 94V-0

Moisture sensitivity level (MSL): level 1, per J-STD-020

Part No. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free)

Terminal: Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

Weight: 0.06 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)			
PARAMETER	SYMBOL	ES1DV	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	200	V
Maximum RMS voltage	V _{RMS}	140	V
Maximum DC blocking voltage	V _{DC}	200	V
Maximum average forward rectified current	I _{F(AV)}	1	A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30	A
Maximum instantaneous forward voltage (Note 1) @ 1 A	V _F	0.92	V
Maximum reverse current @ rated V _R T _J =25°C T _J =125°C	I _R	5 100	μA
Maximum reverse recovery time (Note 2)	t _{rr}	15	ns
Typical junction capacitance (Note 3)	C _J	17	pF
Typical thermal resistance	R _{θJL} R _{θJA}	35 85	°C/W
Operating junction temperature range	T _J	- 55 to +150	°C
Storage temperature range	T _{STG}	- 55 to +150	°C

Note 1: Pulse test with PW=300μs, 1% duty cycle

Note 2: Test conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and applied V_R=4.0 V

ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX (*)	PACKAGE	PACKING
ES1DV	H	R3	G	SMA	1,800 / 7" Plastic reel
		R2		SMA	7,500 / 13" Paper reel
		M2		SMA	7,500 / 13" Plastic reel
		F3		Folded SMA	1,800 / 7" Plastic reel
		F2		Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel

*: Optional available

EXAMPLE					
EXAMPLE PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ES1DVHR3G	ES1DV	H	R3	G	AEC-Q101 qualified Green compound

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

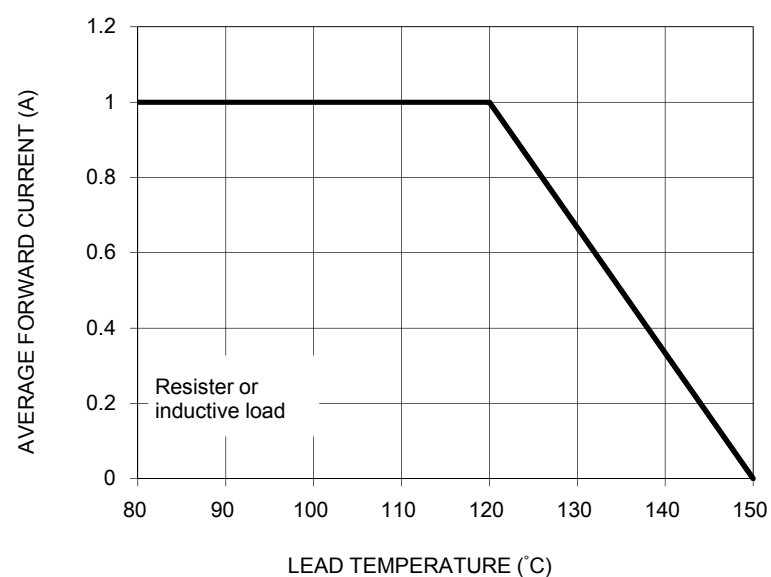


FIG. 2 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

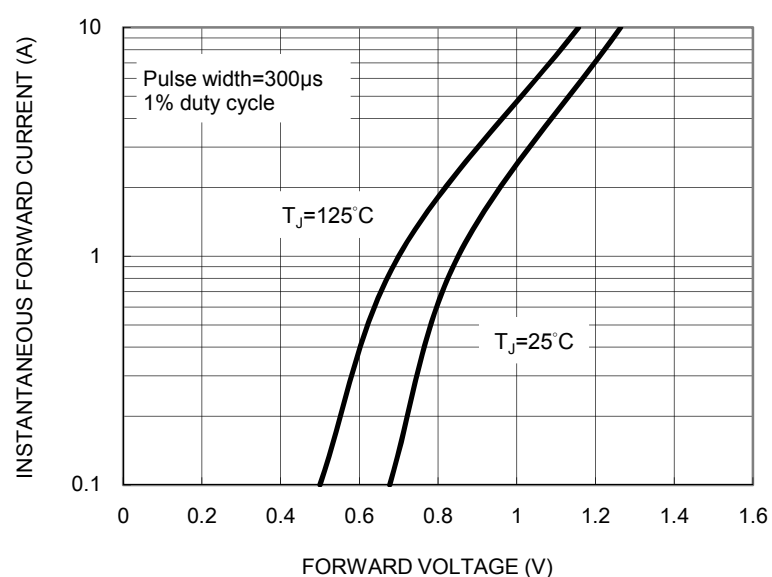


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD PEAK SURGE CURRENT

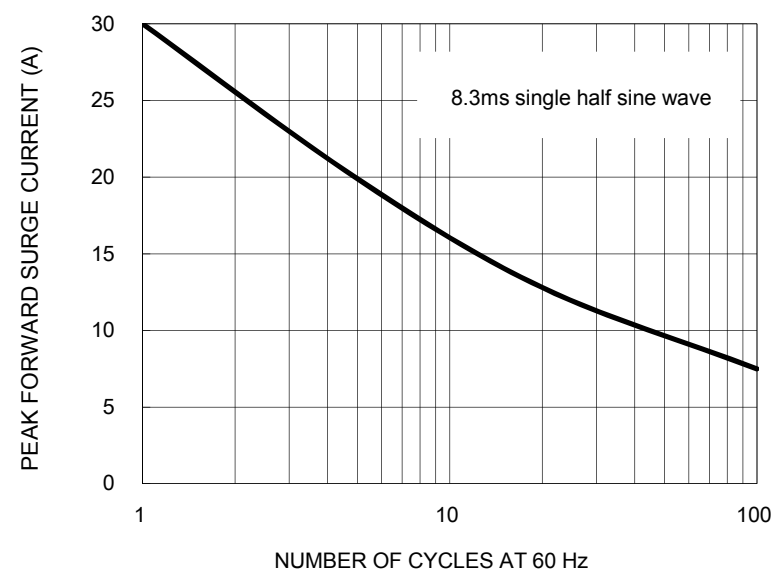


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

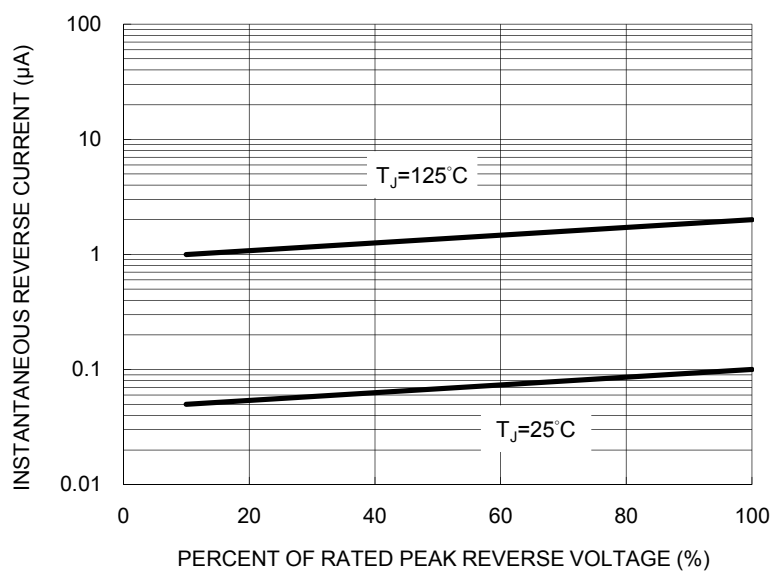
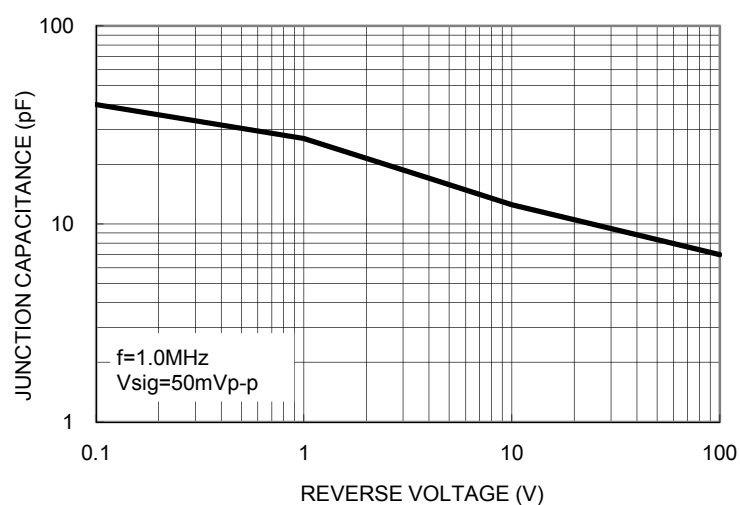
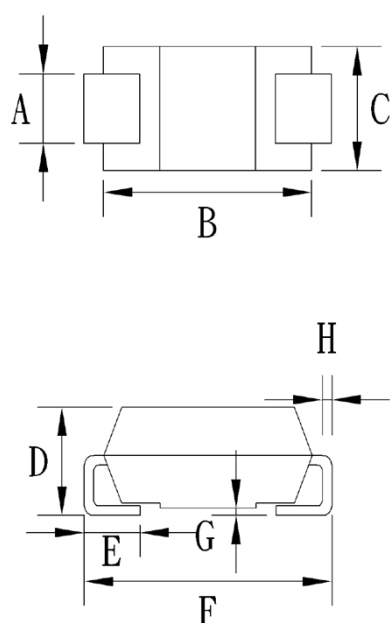


FIG. 5 TYPICAL JUNCTION CAPACITANCE



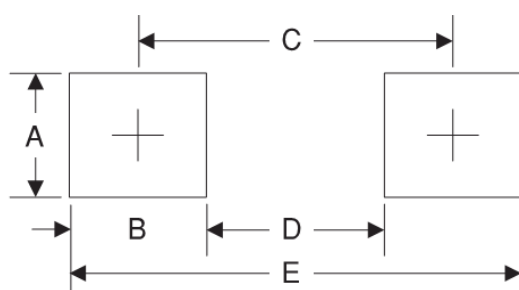
PACKAGE OUTLINE DIMENSIONS

DO-214AC (SMA)



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	1.27	1.58	0.050	0.062
B	4.06	4.60	0.160	0.181
C	2.29	2.83	0.090	0.111
D	1.99	2.50	0.078	0.098
E	0.90	1.41	0.035	0.056
F	4.95	5.33	0.195	0.210
G	0.10	0.20	0.004	0.008
H	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



P/N = Specific Device Code
 G = Green Compound
 YW = Date Code
 F = Factory Code

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9